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Client/Matter No. Infineon Ref. No. IN1250WC 11-2 (BHGL Case No. 10808/146)		JUL 2025		
RECC	HEET			
6/2/5 103	123762 10/5			
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below:				
1. Name of conveying Party(ies)/Execution Date:	2. Name and Address of receiving Party(ies):			
RONALD KAKOSCHKE	Name: INFINEON TECHNOI	OGIES		
DANNY SHUM	AG			
GEORG TEMPEL	10			
	Internal Address:			
Execution Date(s):Kakoschke & Tempel 6/20/05; Shum				
7/13/05	Street Address: StMartin-Str. 53			
Additional name(s) of conveying party(ies) attached?	City: 81669 Munich			
3. Nature of Conveyance:	City: 81669 Munich			
Assignment Change of Name	State:			
Security Agreement Merger				
	Country: Germany Zip:			
Government Interest Assignment				
Executive Order 9424, Confirmatory License	Additional name(s) and addresses attached? Yes X No			
Other				
·····	ent is being filed together with a new application.			
A. Patent Application No.(s) 10/513,163	B. Patent No.(s)			
\int				
Additional numbers at				
 Name and address of party to whom correspondence concerning document should be 	6. Total number of applications and patents involv	ed: <u>1</u>		
mailed:				
BRINKS HOFER GILSON & LIONE	7. Total fee (37 CFR 1.21(h) & 3.41)	\$ <u>40.00</u>		
P.O. BOX 10395 CHICAGO, IL 60610	Authorized to be charged by credit card.			
(312) 321-4200	Authorized to be charged to Deposit Account	No. 23-		
(312) 321-4299 Fax	1925. Enclosed			
	None required (government interest not affecti	ng title)		
	8. Payment Information:			
	a. 🗌 Credit Card: Last 4 Numbers			
	Expiration Date			
	b. Charge fee and/or any Deficiencies to Depo	sit		
	Account Number: 23-1925			
	Authorized User Name: Brinks Hofer Gilso	on & Lione		
9. Signature:	7/12/05			
9. Signature: Date				
James L. Katz Total number of pages including cover Name of Person Signing sheet, attachments, and documents: <u>7</u>				
Documents to be recorded (including cover shee	t) should be faxed to (703) 306-5995, or mailed to:			
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450				

INFINEON REF NO. In1250WOUS O.C. REF NO. 10808/146

ASSIGNMENT

For good and valuable consideration, I, Ronald Kakoschke, a citizen of Germany, residing at Karlsbergstr. 11, 81475 München, Germany, Danny Shum, a citizen of U.S.A., residing at 26 Tall Tree In., Poughkeepsie, New York 12601, and Georg Tempel, a citizen of Germany, residing at Berggartenstraße 23 b. 01277 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby scil, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

US. Serial No. 10/513,163 . filed on November 1, 2004

entitled: BIT LINE STRUCTURE AND METHOD OF FABRICATION

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all forcign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignce, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

onald Kalherdon DATE: June 20, 2005 SIGNATURE:

NAME: Ronald Kakoschke

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SIGNATURE: NAME: Danny Shum

]	DATE:		
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SIGNATURE: _________ NAME: Georg Tempel

_____ DATE: _____

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INFINEON REF NO. <u>In1250WOUS</u> O.C. REF NO. <u>10808/146</u>

ASSIGNMENT

For good and valuable consideration, I, <u>Ronald Kakoschke</u>, a citizen of <u>Germany</u>, residing at <u>Karlsbergstr. 11, 81475 München, Germany</u>, <u>Danny Shum</u>, a citizen of <u>U.S.A.</u>, residing at <u>26 Tall Tree</u> <u>Ln., Poughkeepsie, New York 12601</u>, and <u>Georg Tempel</u>, a citizen of <u>Germany</u>, residing at <u>Berggartenstraße 23 b, 01277 Dresden, Germany</u>, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Tcchnologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on November 1, 2004 US. Serial No. <u>10/513.163</u>,

entitled: BIT LINE STRUCTURE AND METHOD OF FABRICATION

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents on said improvements, in said Assignee, its successors, assigns and legal representatives on said improvements, in

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

NAME: Ronald Kakoschke

_____ DATE: _____

Пат. DATE: 13-7-2005 Vam SIGNATURE: NAME: Danny Shum

DATE:

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INFINEON REF NO. <u>1n1250WOUS</u> O.C. REF NO. <u>10808/146</u>

ASSIGNMENT

For good and valuable consideration, I, <u>Ronald Kakoschke</u>, a citizen of <u>Germany</u>, residing at <u>Karlsbergstr. 11, 81475 München, Germany</u>, <u>Danny Shum</u>, a citizen of <u>U.S.A.</u>, residing at <u>26 Tall Tree</u> <u>Ln., Poughkeepsie, New York 12601</u>, and <u>Georg Tempel</u>, a citizen of <u>Germany</u>, residing at <u>Berggartenstraße 23 b, 01277 Dresden, Germany</u>, hereinafter individually or collectively referred to as "Assignor";

Hereby scll, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on November 1, 2004 US. Serial No. <u>10/513.163</u>,

entitled: BIT LINE STRUCTURE AND METHOD OF FABRICATION

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignce may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

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SIGNATURE:

DATE: _____

NAME: Ronald Kakoschke

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SIGNATURE:		DATE:
	NAME: Danny Shum	
SIGNATURE:	le or en pel NAME: Georg Tempel	DATE: 2005-06-20

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PATENT REEL: 017238 FRAME: 0012

RECORDED: 07/22/2005